## 502914531 07/30/2014

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT2961129

| SUBMISSION TYPE:      | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT     |

## **CONVEYING PARTY DATA**

| Name             | Execution Date |
|------------------|----------------|
| SHIH-CHENG CHANG | 07/04/2014     |
| LIANG-CHEN LIN   | 07/04/2014     |
| FU-TSAI HOU      | 07/04/2014     |
| TUNG-CHIN YEH    | 07/04/2014     |
| SHIH-KAI LIN     | 07/04/2014     |
| GIA-HER LU       | 07/07/2014     |
| JYUN-LIN WU      | 07/08/2014     |
| HSIEN-PIN HU     | 07/11/2014     |

## **RECEIVING PARTY DATA**

| Name:           | Taiwan Semiconductor Manufacturing Company, Ltd.    |  |
|-----------------|---|--|
| Street Address: | No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park |  |
| City:           | Hsin-Chu  |  |
| State/Country:  | TAIWAN  |  |
| Postal Code:    | 300-77  |  |

## **PROPERTY NUMBERS Total: 1**

| Property Type       | Number   |  |
|---------------------|----------|--|
| Application Number: | 14334389 |  |

## **CORRESPONDENCE DATA**

**Fax Number:** (972)732-9218

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 972-732-1001

**Email:** docketing@slater-matsil.com **Correspondent Name:** SLATER & MATSIL, L.L.P.

Address Line 1: 17950 PRESTON RD., SUITE 1000

Address Line 4: DALLAS, TEXAS 75252

| ATTORNEY DOCKET NUMBER: | TSM13-1142                 |
|-------------------------|----------------------------|
| NAME OF SUBMITTER:      | LISETTE REYES-WASHINGTON   |
| SIGNATURE:              | /Lisette Reyes-Washington/ |
| DATE SIGNED:            | 07/30/2014                 |
|                         | PAICNI                     |

502914531 REEL: 033425 FRAME: 0336

This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 2** 

 $source = TSM13-1142\_Assignment\_pto\#page1.tif$ 

source=TSM13-1142\_Assignment\_pto#page2.tif

PATENT REEL: 033425 FRAME: 0337

ATTORNEY DOCKET NO. TSM13-1142

#### **ASSIGNMENT**

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. ("Assignee"), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6 Science-Based Industrial Park, Hsin-Chu 300-77 Taiwan, R.O.C., is desirous of acquiring my entire right, title and interest in and to said invention, and to said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to said Assignee, its successors and assigns, my entire right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all future non-provisional applications including divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to said Assignee, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to Assignee, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said Assignee, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said Assignee, its legal representatives, successors, or assigns, will testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said Assignee, its legal representatives, successors, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

| TITLE<br>OF<br>INVENTION                | Capacitor with Fuse Protection |                        |                            |                                 |
|---|--------------------------------|------------------------|----------------------------|---------------------------------|
| SIGNATURE<br>OF<br>INVENTOR<br>AND NAME | Scatt Lin<br>Shih-Kai Lin      | Gay Lu<br>Gia-Her Lu   | Jyun Jin Wi<br>Jyun-Lin Wu | Nacien Pin IIII<br>Hsien-Pin Hu |
| DATE                                    | 07/04/2014                     | 07/07/2014.            | 07/08/2014                 | V107/11/2014                    |
| RESIDENCE                               | Hsin-Chu, Taiwan               | Zhubei City,<br>Taiwan | Hsin-Chu, Taiwan           | Zhubei City, Taiwan             |

ATTORNEY DOCKET NO. TSM13-1142

## **ASSIGNMENT**

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. ("Assignee"), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6 Science-Based Industrial Park, Hsin-Chu, 300-77 Taiwan, R.O.C., is desirous of acquiring my entire right, title and interest in and to said invention, and to said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to said Assignee, its successors and assigns, my entire right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all future non-provisional applications including divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to said Assignee, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to Assignee, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said Assignee, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said Assignee, its legal representatives, successors, or assigns, will testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said Assignee, its legal representatives, successors, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year,

| TITLE<br>OF<br>INVENTION                | Capacitor with Fuse Protection |                           |                  |                            |
|---|--------------------------------|---------------------------|------------------|----------------------------|
| SIGNATURE<br>OF<br>INVENTOR<br>AND NAME |                                | ( , )                     | n Ten Tsai Hou   | 1 9                        |
|   | Shih-Cheng Chang               | Liang-Chen Lin            | Fu-Tsai Hou      | Tung-Chin Yeh              |
| DATE                                    | 07/04/2014                     | 7/4/2014                  | 7/34/14          | V 7/04.18.                 |
| RESIDENCE                               | Hsin-Chu, Taiwan               | Baoshan Shiang,<br>Taiwan | Hsin-Chu, Taiwan | Toufen Township,<br>Taiwan |

TSM13-1142

Page 1 of 2

Assignment

PATENT REEL: 033425 FRAME: 0339